

PATENT
4823-0101P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:	SUNG, Ki Suk et al	Conf.:	Unassigned
Appl. No.:	NEW	Group:	Unassigned
Filed:	February 27, 2004	Examiner:	Unassigned
For:	LASER MODULE PACKAGE AND METHOD OF MANUFACTURING THE SAME		

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

February 27, 2004

Sir:

The following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

This amendment includes Amendments to the Specification and Remarks.